

SOD323 Plastic-Encapsulate Diodes

Small Signal Fast Switching Diodes

Features

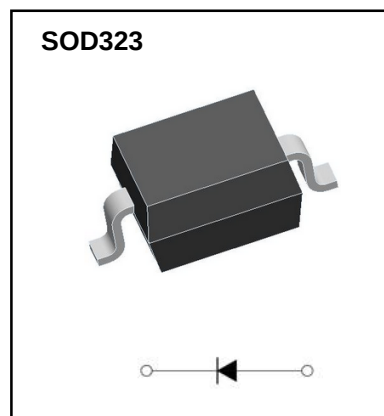
- Fast Switching Speed
- Surface Mount Package Ideally Suited for Automatic Insertion
- For General Purpose Switching Applications
- High Conductance

Applications

- Extreme fast switches

Marking

- BAV16WS:T6
- 1N4148WS:T4



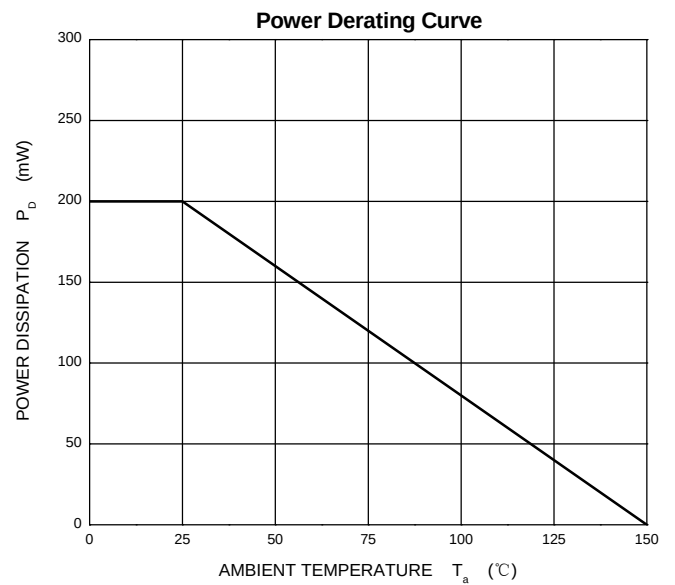
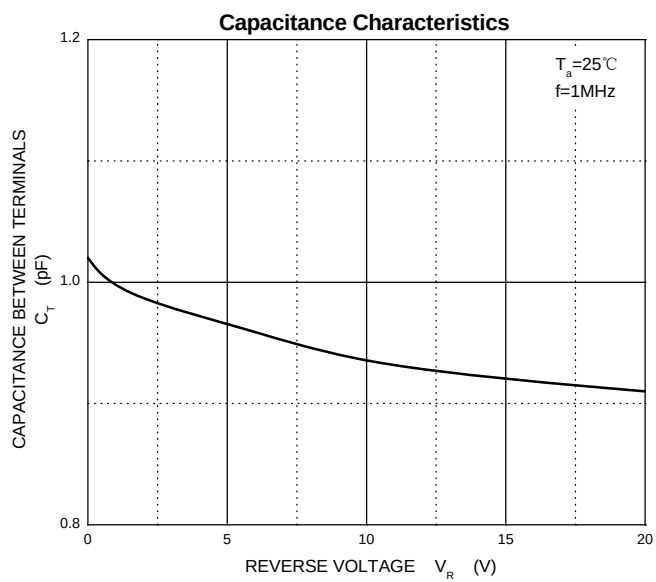
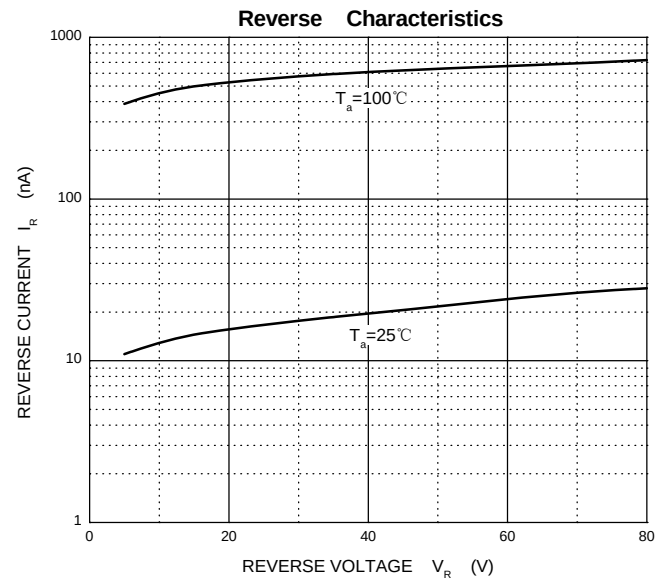
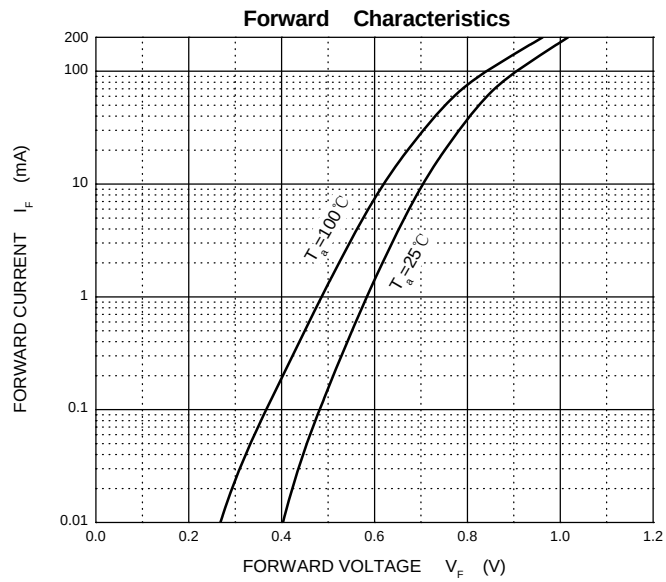
Limiting Values (Absolute Maximum Rating)

Parameter	Symbol	Limit	Unit
Non-Repetitive Peak Reverse Voltage	V_{RM}	100	V
Peak Repetitive Peak Reverse Voltage	V_{RRM}	100	V
Working Peak Reverse Voltage	V_{RWM}		
DC Blocking Voltage	V_R		
RMS Reverse Voltage	$V_{R(RMS)}$	71	V
Forward Continuous Current	I_{FM}	300	mA
Average Rectified Output Current	I_O	150	mA
Non-Repetitive Peak Forward Surge Current @t=8.3ms	I_{FSM}	2.0	A
Power Dissipation	P_d	200	mW
Thermal Resistance from Junction to Ambient	$R_{\theta JA}$	625	°C/W
Junction Temperature	T_j	150	°C
Storage Temperature	T_{STG}	-55~+150	°C

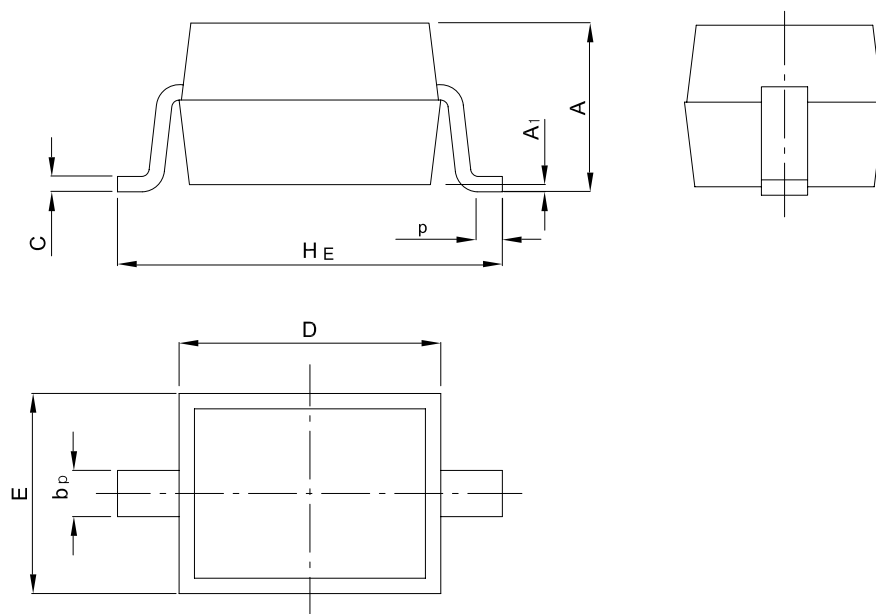
Electrical Characteristics ($T_A=25^{\circ}\text{C}$ unless otherwise noted)

Parameter	Symbol	Min	Typ	Max	Unit	Conditions
Forward voltage	V_{F1}			0.715	V	$I_F=1\text{mA}$
	V_{F2}			0.855	V	$I_F=10\text{mA}$
	V_{F3}			1.0	V	$I_F=50\text{mA}$
	V_{F4}			1.25	V	$I_F=150\text{mA}$
Reverse current	I_{R1}			1	μA	$V_R=75\text{V}$
	I_{R2}			25	nA	$V_R=20\text{V}$
Capacitance between terminals	C_T			2	pF	$V_R=0\text{V}, f=1\text{MHz}$
Reverse recovery time	t_{rr}			4	ns	$I_F=I_R=10\text{mA}$ $I_{rr}=0.1I_{R1}, R_L=100\Omega$

Typical Characteristics

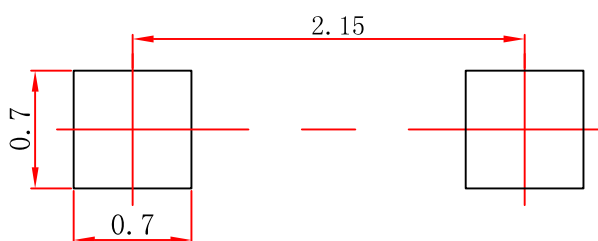


SOD323 Package Outline Dimensions



UNIT	A	b_p	C	D	E	H_E	A_1	L_p
mm	1.20 0.80	0.40 0.25	0.15 0.10	1.80 1.60	1.35 1.15	2.80 2.30	0.10 0.01	0.50 0.20

SOD323 Suggested Pad Layout



Note:

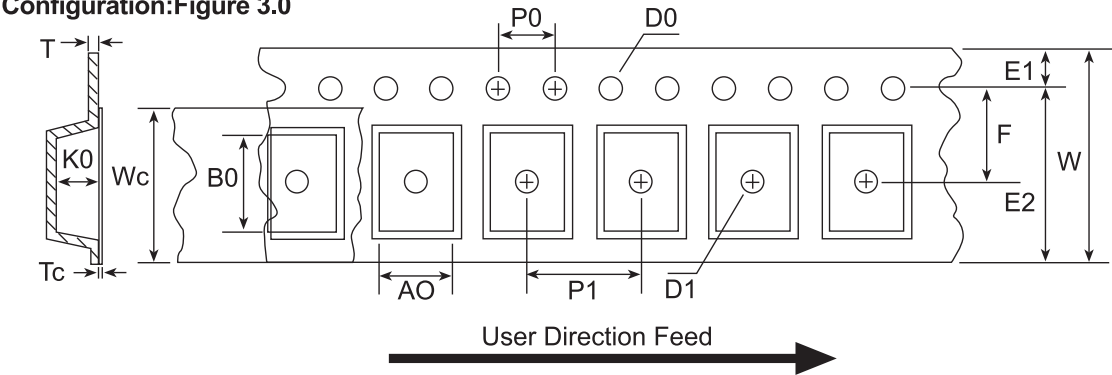
1. Controlling dimension: in millimeters.
2. General tolerance: ± 0.05 mm.
3. The pad layout is for reference purposes only.

NOTICE

JSHD reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to any product herein. JSHD does not assume any liability arising out of the application or use of any product described herein.

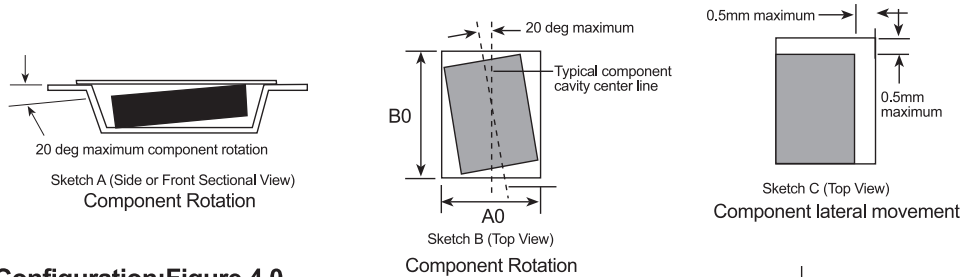
Reel Taping Specifications For Surface Mount Devices–SOD323

SOD323 Embossed Carrier Tape
Configuration:Figure 3.0

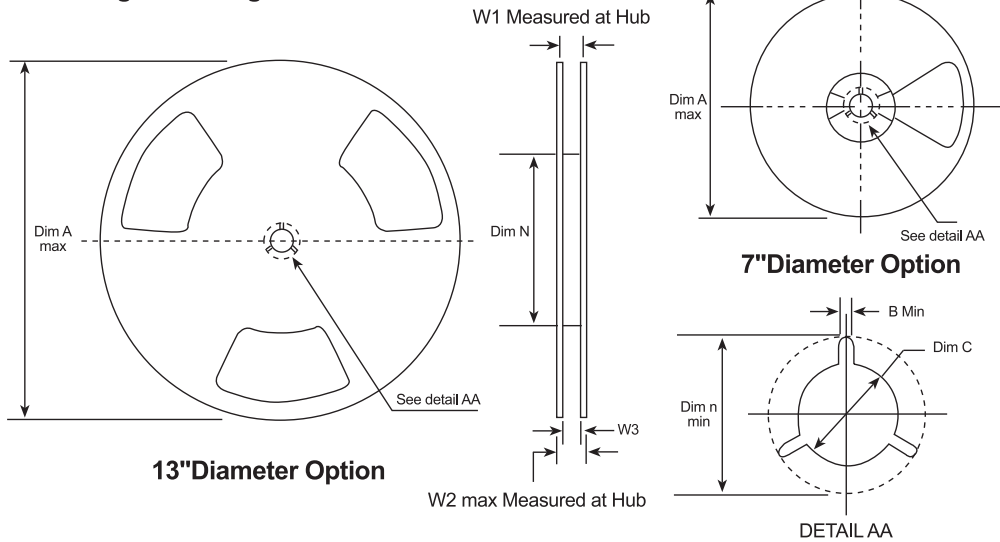


Dimensions are millimeter														
Pkg type	A0	B0	W	D0	D1	E1	E2	F	P1	P0	K0	T	Wc	Tc
SOD323 (8mm)	1.46 +/-0.10	2.9 +/-0.10	8.0 +/-0.3	1.50 +/-0.125	1.125 +/-0.125	1.75 +/-0.10	6.25 min	3.50 +/-0.05	4.0 +/-0.10	4.0 +/-0.10	1.25 +/-0.10	0.25 +/-0.020	5.2 +/-0.20	0.06 +/-0.02

Notes:A0,B0 and K0 dimensions are determined with respect to the EW Jeced RS-481 rotational and lateral movement requirements (see sketches A,B and C).



SOD323 Reel Configuration:Figure 4.0



Dimensions are in inches and millimeter									
Type Size	Reel Option	Dim A	Dim B	Dim C	Dim D	Dim N	Dim W1	Dim W2	Dim W3 (LSL-USL)
8mm	7" Dia	7.00 177.8	0.059 1.5	512+0.020/-0.008 13+0.5/-0.2	0.795 20.0	2.165 55	0.331+0.059/-0.000 8.4+1.5/0	0.567 14.4	0.311-0.429 7.9-10.9
8mm	13" Dia	13.00 330	0.059 1.5	512+0.020/-0.008 13+0.5/-0.2	0.795 20.0	4.00 100	0.331+0.059/-0.000 8.4+1.5/0	0.567 14.4	0.311-0.429 7.9-10.9